

C0805C301FBGACTU

Aliases (C0805C301FBGAC7800) SMD Comm COG HV, Ceramic, 300 pF, 1%, 630 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805, 0.7 mm



Click here for the 3D model.

| General Information | | |
|--------------------------|---|--|
| Series | SMD Comm COG HV | |
| Style | SMD Chip | |
| Description | SMD, MLCC, Ultra-Stable, Low Loss, Class I | |
| Features | Ultra-Stable, Low Loss, Class I | |
| RoHS | Yes | |
| Termination | Tin | |
| Marking | No | |
| AEC-Q200 | No | |
| Typical Component Weight | 14 mg | |
| Shelf Life | 78 Weeks | |
| MSL | 1 | |

| Specifications | |
|--|---------------------------|
| Capacitance | 300 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Tolerance | 1% |
| Voltage DC | 630 VDC |
| Dielectric Withstanding Voltage | 945 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | COG |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour |
| Insulation Resistance | 100 GOhms |

 Dimensions

 Chip Size
 0805

 L
 2mm +/-0.2mm

 W
 1.25mm +/-0.2mm

 T
 1.25mm +/-0.15mm

 S
 0.7mm MIN

 B
 0.5mm +/-0.25mm

Packaging SpecificationsPackagingT&RPackaging Quantity2500

T&R, 180mm, Plastic Tape 2500

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